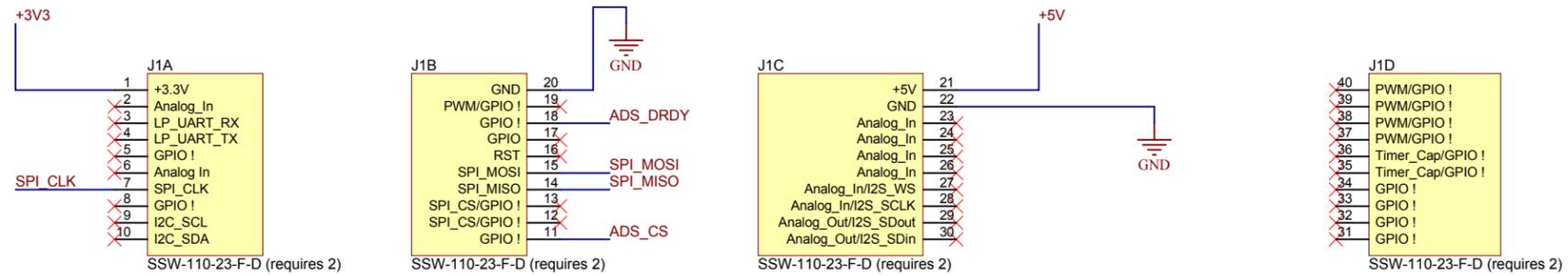
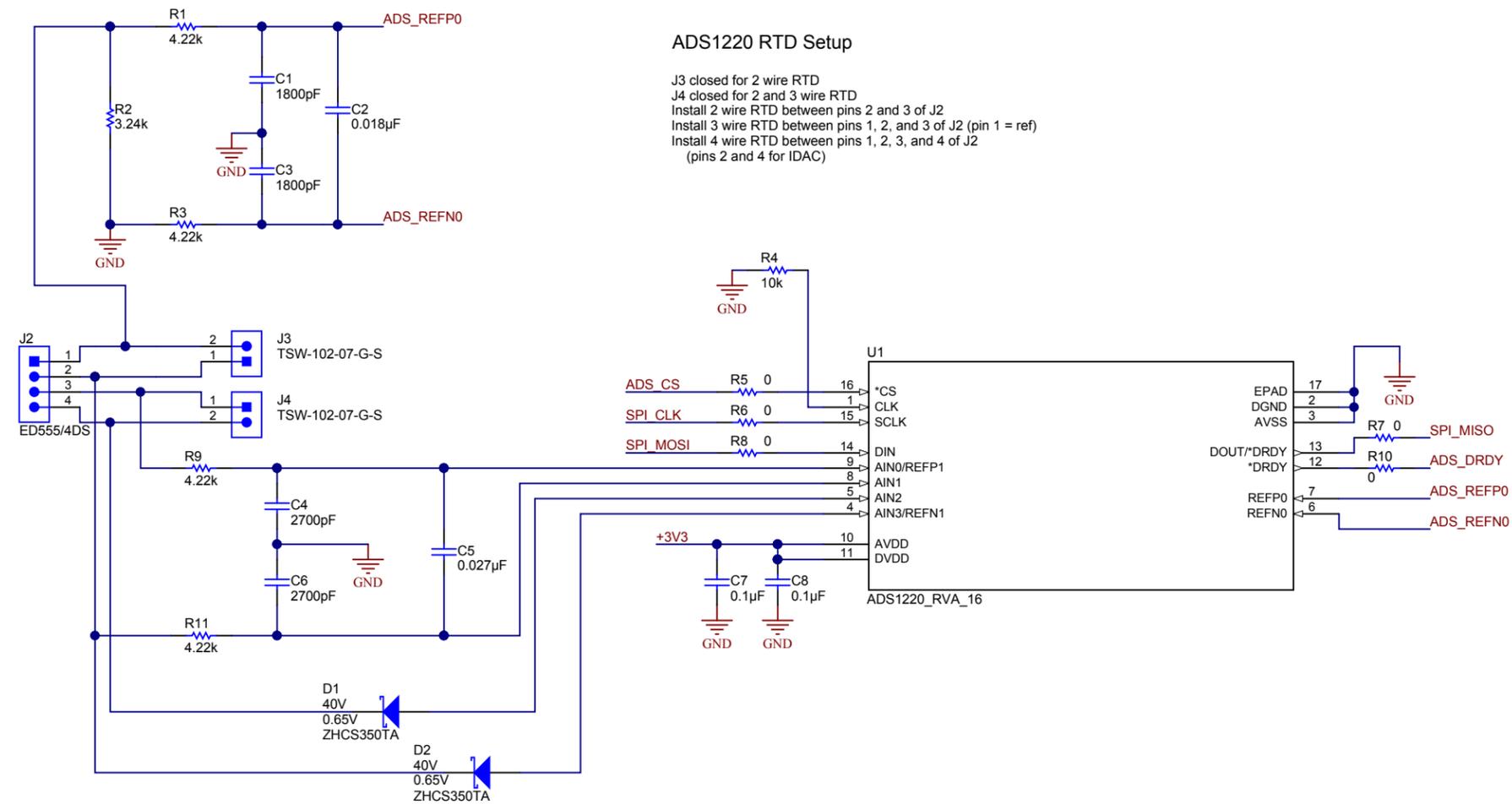


40-pin BoosterPack Headers



ADS1220 RTD Setup

J3 closed for 2 wire RTD
 J4 closed for 2 and 3 wire RTD
 Install 2 wire RTD between pins 2 and 3 of J2
 Install 3 wire RTD between pins 1, 2, and 3 of J2 (pin 1 = ref)
 Install 4 wire RTD between pins 1, 2, 3, and 4 of J2
 (pins 2 and 4 for IDAC)



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Designed for: Public Release	Mod. Date: 2/11/2015	
Project Title: Change in menu Project Project Options Parameters	Sheet Title:	
Number: XX####	Rev: E1	Assembly Variant: [No Variations] File: ADS1220_RT_D_BP.SchDoc Engineer: Enter name of project lead
SVN Rev: Version control disabled	Sheet: 1 of 1	Size: B Contact: http://www.ti.com/support
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